Tantalum Capacitors Niobium Oxide Capacitors



AVX is a leading worldwide manufacturer and supplier of a broad line of passive electronic components and Interconnects.

AVX enjoys significant competitive advantages including the benefit of having research, manufacturing, and customer support facilities in 15 countries around the world. This assures customers of the most efficient balance of delivery and production capability in response to their just-in-time inventory requirements. With major research and development centers in five locations around the world, AVX has fostered customer relationships involving the design and technology for new and advanced products to fulfill their special end product requirements.

AVX research and development has anticipated and adapted products that help fuel the explosive growth in communications technology.

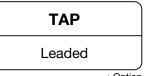
Tantalum Capacitors/ Niobium Oxide Capacitors Series Guide

	Resin-Molded								
	Standard								
General	(Standard)	Low F	Profile		Low ES	R		Face-	Down
F93	TAJ	F92	TAJ	F91	TPS	ТРМ		F98	F98-AS1
Small Case	High Voltage	Small Case	High Voltage	Small Case	High Voltage	Multi anode		Small Case High Capacitance	Fused
			High Re	eliability	/				
General (Hi	igh Reliability)	Small Case Hig	gh Capacitance		Low ES	R		High Ten	perature
F97	TRJ	F93 -	-AJ6	F91-A	J 6	TRM		F97-HT3	THJ
Small Case	High Voltage			Small Ca High Capac		Multi anode		Small Case	High Voltage

Conductive Polymer					
Ultra Small Case High Capacitance F38	Small Case High Capacitance TCN	High Voltage TCJ	Low ESR TCM		

Conformal Coated				
Small Case Low Profile	Low Profile	High Capacitance		
F95-AM1 (AUDIO)	F72) (F75		

Niobium Oxide Capacitors OxiCap®						
General	Low ESR	Multianode				
NOJ NOS NOM						



Tantalum Capacitors Niobium Oxide Capacitors



Tantalum Capacitors Product Line-up

Series			Resin-Molded (Standard		
Series	F93	TAJ	F92	TAJ (Low Profile)	F91
Features	General Small Case	General High Voltage	Low Profile Small Case	Low Profile High Voltage	Low ESR Small Case
Appearance	4		4		
Туре	Resin-Molded Chip				
Operating Temperature Range (°C)	-55 to +125				
Voltage Range (V)	4 to 35	2.5 to 50	4 to 35	2.5 to 50	4 to 35
Capacitance (µF)	0.68 to 680	0.1 to 2200	0.22 to 150	0.1 to 1000	6.8 to 680
Tolerance (%)	±20, ±10	±20, ±10	±20	±20, ±10	±20, ±10
Leakage Current (µA)	0.01CV or 0.5 max.	0.5 to 60	0.01CV to 0.1CV or 0.5 max.	0.5 to 28.2	0.01CV or 0.5 max.
Dissipation Factor (%)	4 to 40 max.	4 to 60 max.	4 to 30 max.	4 to 30 max.	6 to 18 max.
Failure Rate Level	at 85°C Rated Voltage Applied 1% / 1000 hours				
Typical applications*		Consur	ner products, Industrial equ	uipments	

Series	Resin-Molde	d (Standard)	Re	sin-Molded (High Reliabi	lity)
Series	TPS/ TPM	F98/ F98-AS1	F97	TRJ	F93-AJ6
Features	Low ESR High Voltage Multianode (TPM)	•Face-Down Terminal •Small Case •High Capacitance •Fused type (F98-AS1)	•General •Small Case	General High Voltage	Small Case High Capacitance
Appearance		•			4
Туре	Resin-Molded Chip	Resin-Molded Chip	Resin-Molded Chip	Resin-Molded Chip	Resin-Molded Chip
Operating Temperature Range (°C)	-55 to +125	-55 to +125	-55 to +125	-55 to +125	-55 to +125
Voltage Range (V)	2.5 to 50	2.5 to 35 (F98) 10 to 35 (F98-AS1)	6.3 to 35	6.3 to 50	4 to 35
Capacitance (µF)	0.15 to 2200	1 to 220 (F98) 1 to 47 (F98-AS1)	0.33 to 150	0.1 to 680	1 to 680
Tolerance (%)	±20, ±10	±20	±20, ±10	±20, ±10	±20, ±10
Leakage Current (µA)	0.5 to 63	0.01CV to 0.2CV or 0.5 max.	0.01CV or 0.5 max.	0.3 to 39	0.01CV or 0.5 max.
Dissipation Factor (%)	4 to 60 max.	6 to 80 max. (F98) 18 to 30 max. (F98-AS1)	4 to 15 max.	4 to 30 max.	4 to 30 max.
Failure Rate Level	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 0.5% / 1000 hours	at 85°C Rated Voltage Applied 0.5% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours
Typical applications*	Consumer products,	Industrial equipments	Automot	tive products, Industrial eq	uipments

Cardon	Resin-Molded (High Reliability)					
Series	F91-AJ6	TRM	F97-HT3	THJ		
Features	Low ESR Small Case High Capacitance	Low ESR Multianode	Temperature 135°C Small Case High Capacitance	•Temperature 175°C, 200°C •High Voltage		
Appearance						
Туре	Resin-Molded Chip	Resin-Molded Chip	Resin-Molded Chip	Resin-Molded Chip		
Operating Temperature Range (°C)	-55 to +125	-55 to +125	-55 to +135	-55 to +175, +200		
Voltage Range (V)	6.3 to16	2.5 to 50	6.3 to 35	6.3 to 50		
Capacitance (µF)	10 to 47	4.7 to 1500	0.33 to 100	0.1 to 220		
Tolerance (%)	±20, ±10	±20, ±10	±20, ±10	±20, ±10		
Leakage Current (µA)	0.01CV or 0.5 max.	1.8 to 30	0.01CV or 0.5 max.	0.5 to 22		
Dissipation Factor (%)	6 to 12 max.	6 to 8 max.	4 to 15 max.	3 to 10 max.		
Failure Rate Level	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 0.5% / 1000 hours	at 95°C Rated Voltage Applied 0.5% / 1000 hours	at 85°C Rated Voltage Applied 0.5% / 1000 hours		
Typical applications*		Automotive products,	Industrial equipments			

^{*} This table is not intended to limit the applications. Please see each page of products for detailed specifications.

Tantalum Capacitors Niobium Oxide Capacitors



Tantalum Capacitors Product Line-up

Carriera		Conductiv	e Polymer	
Series	F38	TCN	TCJ	ТСМ
Features	Oltra Small case High Capacitance Face-Down Terminal Low ESR High Ripple	Small case High Capacitance Face-Down Terminal Low ESR High Ripple	High Voltage Low ESR High Ripple	Oltra Low ESR High Ripple Multianode
Appearance	4			
Туре	Conductive Polymer Resin Molded Chip	Conductive Polymer Resin Molded Chip	Conductive Polymer Resin Molded Chip	Conductive Polymer Resin Molded Chip
Operating Temperature Range (°C)	-55 to +105	-55 to +105	-55 to +85, +105, +125	-55 to +105
Voltage Range (V)	4 to 10	6.3 to 35	2.5 to 125	4 to 100
Capacitance (µF)	2.2 to 100	4.7 to 1000	0.47 to 470	10 to 1000
Tolerance (%)	±20	±20	±20	±20
Leakage Current (µA)	0.2CV or 10 max.	35 to 600	2.5 to 282	77 to 408
Dissipation Factor (%)	6 to 15 max	6 to 30 max.	6 to 12 max.	8 max.
Failure Rate Level	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours
Typical applications*		Consumer products,	Industrial equipments	<u> </u>

Carrian		Conformal Coated	
Series	F95-AM1/ F95	F72	F75
Features	For Audio Equipment (F95-AM1) Small Rectangular Low ESR/ impedance, Excellent High Frequency Characteristics	Low Profile High Capacitance Low ESR/ impedance, Excellent High Frequency Characteristics	High Capacitance Low ESR/ impedance, Excellent High Frequency Characteristics
Appearance		4	
Туре	Coformal Coated Chip	Coformal Coated Chip	Coformal Coated Chip
Operating Temperature Range (°C)	-55 to +125	-55 to +125	-55 to +125
Voltage Range (V)	4 to 10 (F95-AM1) / 4 to 35 (F95)	4 to 16	4 to 16
Capacitance (μF)	68 to 470 (F95-AM1) / 1 to 470 (F95)	33 to 1500	68 to 2200
Tolerance (%)	±20, ±10	±20, ±10	±20, ±10
Leakage Current (µA)	0.01CV to 0.02CV or 0.5 max.	0.01CV to 0.02CV or 0.5 max.	0.01CV to 0.02CV or 0.5 max.
Dissipation Factor (%)	10 to 40 max. (F95-AM1) / 4 to 40 max (F95)	6 to 45 max.	10 to 45 max.
Failure Rate Level	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours	at 85°C Rated Voltage Applied 1% / 1000 hours
Typical applications*	Cons	sumer products, Industrial equipn	nents

Niobium Oxide Capacitors OxiCap® Product Line-up

Miobium Oxide Oapacitors Oxidap Froduct Line up				
Series	Niobium Oxide Ca	apacitors OxiCap®		
Series	NOJ	NOS/ NOM		
Features	Non burn safe technology General	Non burn safe technology Low ESR Multianode (NOM)		
Appearance				
Туре	Resin-Molded Chip	Resin-Molded Chip		
Operating Temperature Range (°C)	-55 to +105	-55 to +125		
Voltage Range (V)	1.8 to 10	1.8 to 8		
Capacitance (µF)	4.7 to 1000	10 to 1000		
Tolerance (%)	±20	±20		
Leakage Current (µA)	1.1 to 80	1.1 to 56.4		
Dissipation Factor (%)	6 to 20 max.	6 to 16 max.		
Failure Rate Level	at 85°C Rated Voltage Applied 0.5% / 1000 hours	at 85°C Rated Voltage Applied 0.2% / 1000 hours		
Typical applications*	Automotive products, Industrial equipments, Consumer products			

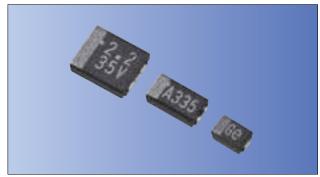
^{*} This table is not intended to limit the applications. Please see each page of products for detailed specifications.

Compliance with RoHS Directive

	=
Compliance with	Compliant
RoHS Directive	Compilant
Leaded (Pb)	
Chromium(VI)	
Mercury	Does not contain
Cadmium	Does not contain
PBB	
PBDE	
MSL (IPC/ JEDC J-STD-020)	* LEVEL 1 to LEVEL 3

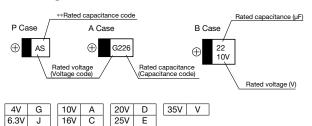
^{*} If you need detailed information about MSL LEVEL, please contact us.





RoHS Compliant

Marking

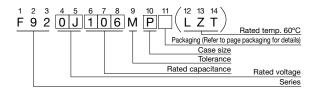


^{**} Capacitance code of "P" case products are as shown below.

Specifications

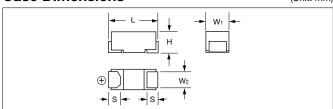
	Performance	Characteristics			
Item	P Case	A/ B Case			
Category Temperature Range	-55 to +125°C (Rated temperature : +85°C or +60°C)				
Tolerance	±20% (at 120Hz)				
Dissipation Factor	Refer to Next Page (120Hz)				
ESR	Refer to Next Page (100kHz)				
Leakage Current*	 After 1 minute application of rated voltage, leakage current at 20°C is not more than 0.01 CV or 0.5µA, whichever is greater. After 1 minute application of rated voltage, leakage current at 85°C (or 60°C) is not more than 0.1 CV or 5µA, whichever is greate After 1 minute application of derated voltage, leakage current at 125°C is not more than 0.125°C or 6.3µA, whichever is greater. 				
Capacitance Change by Temperature	+20% max. (at +125°C) +15% max. (at +85°C) -15% max. (at -55°C)	+15% max. (at +125°C) +10% max. (at +85°C or +60°C) -10% max. (at -55°C)			
	t 40°C 90 to 95% RH 500 hours (No voltage applied)				
Damp Heat (Steady State)	Capacitance Change Refer to next page (*1) Dissipation Factor150% or less than the initial specified value Leakage Current Initial specified value or less	Refer to next page (*1) Initial specified value or less Initial specified value or less			
	-55°C / +125°C 30 minutes each 5	<u>'</u>			
Temperature Cycles	Capacitance Change Refer to next page (*1) Dissipation Factor150% or less than the initial specified value Leakage Current Initial specified value or less	Refer to next page (*1) Initial specified value or less Initial specified value or less			

How to Order (Example: 6.3V 10µF)



Case Dimensions

/*		
(1	Init:	mm



Case size	L	W ₁	W ₂	Н	S
Р	2.0±0.2	1.25±0.1	0.9±0.1	1.1±0.1	0.5±0.2
Α	3.2±0.2	1.6±0.2	1.2±0.1	1.1±0.1	0.8±0.2
В	3.4±0.2	2.8±0.2	2.3±0.1	1.1±0.1	0.8±0.2

В	3.4±0.2	2.0±0.2	2.3	-0.1	1.1±0.1	0.6±0.2
Item	Performance Characteristics P Case A/B Case					
					A/ B Ca	
Resistance to Soldering Heat	10 seconds reflow at 260°C, 5 seco Capacitance Change Refer to next page (*1) Dissipation Factor150% or less than the initial specified value Leakage Current Initial specified value or less			Refer to	o next page (pecified valu	e or less
	After application of seconds ON, 30 se 85°C, capacitors sh	f surge voltage in se econds OFF (For "P" nall meet the charact	ies with a case : 5.5	33Ω (For "F minutes Ol	D" case : 1kΩ) resis FF), for 1000 succi	stor at the rate of 30 essive test cycles a
Surge*	Capacitance Change Refer to next page (*1) Dissipation Factor150% or less than the initial specified value Leakage Current			Initial s	o next page (e or less
		fied value or le		Initial specified value or less		
Endurance*	(or 60°C), or der meet the charac Capacitance (Refer to ne) Dissipation Fa than the init Leakage Curn	rated voltage in screnistic requirem Change kt page (* 1) actor150% o tial specified vo	eries wit ents tabl r less alue	Refer to next page (*1) Initial specified value or less		
Shear Test	Initial specified value or less Initial specified value or less After applying the pressure load of 5N for 10±1 seconds horizontally to the center of capacitor side body which has no electrode and has been soldered beforehand on a substrate, there shall be found neither exfoliation nor its sign at the terminal electrode. For 10 ± 1 seconds				<u>□</u> <u>□</u> ←	
Terminal Strength	substrate ups substrate at b 45mm apart fi pressure strer at the center of may bend by	pacitor surface- ide down and so oth of the opporom the center right is applied of substrate so 1 mm as illustrat d no remarkable terminals.	supporting the supportion of capacity with a specific that the ted.The	ng the attom point or, the becified substrating, there	jig ==== te 45	20 2 45

^{*} As for the surge voltage and derated voltage at 125°C, refer to page precautions for details. In case of rated temperature 60°C type, test condition is 60°C.

Capacitance and Voltage Range

Capacitai	ice and ve			*					
	V	-	6.3	10	16	20	25	35	* * Capacitance
μ F	CODE	0G	0J	1A	1C	1D	1E	1V	code
0.22	224							A	J
0.33	334							A	N
0.47	474				Р	P/ A		A	S
0.68	684				Р	A			W
1	105			P	Р	P/ A	P/ A	A	A
1.5	155			P	Р	A			E
2.2	225		Р	Р	P/ A	(P) / A	A/B	В	J
3.3	335	P	Р	P/A	Α			В	N
4.7	475	Р	Р	P/A	(P) / A/ B	A/ B	A/B		S
6.8	685	P	Р	P/A	В				w
10	106	P/ A	P/ A	P/A	A/B	В			а
15	156	Р	P/ A	A					е
22	226	P/ A	P/ A	A/B	В				J
33	336	P/ A	A/ B	В					n
47	476	A/B	A/ B	В					s
68	686	A/B							-
100	107	A/B	A/ B						-
150	157	В							-
220	227	(B)							-

^() The series in parentheses are being developed. Please contact us when these series are being designed in your application.

Tantalum Capacitors Resin-molded Chip, Low Profile **F92 Series**



Standard Ratings

Rated Voltage	Cap (μF)	Case	Part Number	Leakage Current	Disspation Factor	ESR (Ω@100kHz)	*1 ∆C/C
90	3.3	P	F920G335MPA	(μΑ)	(%@120Hz) 8	12.0	(%) *
		P		0.5			*
	4.7		F920G475MPA	0.5	8	6.0	*
	6.8	Р	F920G685MPA	0.5	10	6.0	
	10	P	F920G106MPA	0.5	10	6.0	*
	10	A	F920G106MAA	0.5	8	4.0	
	15	P	F920G156MPA	0.6	10	5.0	*
	22	P .	F920G226MPA	0.9	20	5.0	*
	22	A	F920G226MAA	0.9	12	2.8	*
4V	33	P	F920G336MPA	1.3	20	4.0	*
	33	Α	F920G336MAA	1.3	12	2.8	*
	47	Α	F920G476MAA	1.9	18	2.8	*
	47	В	F920G476MBA	1.9	12	1.7	*
	68	Α	F920G686MAA	2.7	25	2.8	±15
	68	В	F920G686MBA	2.7	18	1.5	*
	100	Α	F920G107MAA	4.0	30	2.8	±15
	100	В	F920G107MBA	4.0	18	1.3	*
	150	В	F920G157MBA	6.0	25	1.3	±15
	2.2	Р	F920J225MPA	0.5	8	12.0	*
	3.3	Р	F920J335MPA	0.5	8	12.0	*
	4.7	Р	F920J475MPA	0.5	8	6.0	*
	6.8	Р	F920J685MPA	0.5	10	6.0	*
	10	Р	F920J106MPA	0.6	10	6.0	*
	10	Α	F920J106MAA	0.6	8	4.0	*
	15	Р	F920J156MPA	0.9	10	6.0	*
	15	Α	F920J156MAA	0.9	8	4.0	*
6.3V	22	Р	F920J226MPA	1.4	20	5.0	*
	22	Α	F920J226MAA	1.4	12	2.8	*
	33	Α	F920J336MAA	2.1	12	2.8	*
	33	В	F920J336MBA	2.1	12	1.7	*
	47	A	F920J476MAA	3.0	18	2.8	±15
	47	В	F920J476MBA	3.0	12	1.7	*
	100	A	F920J107MAALZT	63.0	40	3.0	±20
	100	В	F920J107MBA	6.3	20	1.3	±15
	1	P	F921A105MPA	0.5	8	12.0	*
	1.5	P	F921A155MPA	0.5	8	12.0	*
	2.2	P	F921A225MPA	0.5	8	12.0	*
		P					*
	3.3		F921A335MPA	0.5	8	12.0	*
	3.3	A	F921A335MAA	0.5	6	7.0	
	4.7	P	F921A475MPA	0.5	8	6.0	*
	4.7	A	F921A475MAA	0.5	6	4.0	*
10V	6.8	P	F921A685MPA	0.7	8	6.0	*
	6.8	A	F921A685MAA	0.7	6	4.0	*
	10	P .	F921A106MPA	1.0	14	6.0	*
	10	A	F921A106MAA	1.0	8	4.0	*
	15	Α	F921A156MAA	1.5	8	4.0	*
	22	Α	F921A226MAA	2.2	14	4.0	±15
	22	В	F921A226MBA	2.2	8	1.9	*
	33	В	F921A336MBA	3.3	12	1.9	*
	47	В	F921A476MBA	4.7	18	1.9	±15
	0.47	Р	F921C474MPA	0.5	8	20.0	*
	0.68	Р	F921C684MPA	0.5	8	12.0	*
	1	Р	F921C105MPA	0.5	8	12.0	*
	1.5	Р	F921C155MPA	0.5	8	12.0	*
	2.2	Р	F921C225MPA	0.5	8	12.0	*
	2.2	Α	F921C225MAA	0.5	6	7.0	*
16V	3.3	Α	F921C335MAA	0.5	6	7.0	*
	4.7	Α	F921C475MAA	0.8	6	7.0	*
	4.7	В	F921C475MBA	0.8	6	3.0	*
	6.8	В	F921C685MBA	1.1	6	3.0	*
					, .		
			F921C106MAA	1.6	8	7.0	±15
	10 10	A B	F921C106MAA F921C106MBA	1.6 1.6	8 6	7.0 2.0	±15 *

Rated Voltage	Cap (μF)	Case size	Part Number	Leakage Current (µA)	Disspation Factor (%@120Hz)	ESR (Ω@100kHz)	*1 ∆C/C (%)
	0.47	Р	F921D474MPA	0.5	8	20.0	*
	0.47	Α	F921D474MAA	0.5	4	10.0	*
	0.68	A	F921D684MAA	0.5	4	10.0	*
	1	P	F921D105MPA	0.5	8	20.0	*
20V	1	Α	F921D105MAA	0.5	4	10.0	*
200	1.5	Α	F921D155MAA	0.5	6	7.4	*
	2.2	Α	F921D225MAA	0.5	6	7.0	*
	4.7	Α	F921D475MAA	0.9	10	7.0	±10
	4.7	В	F921D475MBA	0.9	6	3.0	*
	10	В	F921D106MBA	2.0	8	3.0	±10
	1	Р	F921E105MPA	0.5	8	20.0	*
	1	Α	F921E105MAA	0.5	6	10.0	*
25V	2.2	Α	F921E225MAA	0.6	8	10.0	±15
25 V	2.2	В	F921E225MBA	0.6	6	4.0	*
	4.7	Α	F921E475MAA	1.2	10	7.0	±10
	4.7	В	F921E475MBA	1.2	6	3.0	*
	0.22	Α	F921V224MAA	0.5	4	10.0	*
	0.33	Α	F921V334MAA	0.5	4	10.0	*
35V	0.47	Α	F921V474MAA	0.5	4	10.0	*
SOV	1	Α	F921V105MAA	0.5	6	10.0	*
	2.2	В	F921V225MBA	0.8	6	4.0	±10
	3.3	В	F921V335MBA	1.2	10	4.0	±10

* 1 : \(\Delta C/C \) Marked "*"

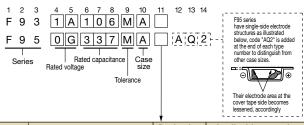
	P Case (%)	A/ B Case (%)
Damp Heat	±20	±10
Tempereature cycles	±10	±5
Resistance soldering heat	±10	±5
Surge	±10	±5
Endurance	±10	±10

We can consider the type of compliance to AEC-Q200.
Please contact us when these series are being designed in your application.

Tantalum Capacitor Packaging



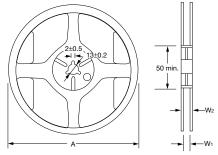
Part Number



Tape				Pack	aging	Applic	able cas	e size	ı
Width (mm)	Polarity			Reel Dia	#330mm	F91/ F92/ F93/ F97/ F98/ F38	F95	F72/ F75	
8 R		Anode is at opposite side of feeding holes.	- 1 1	Α	Е	U/ M/ S/ P/ A/ B	R/ P/ Q/ S/ A/ T/ B	-	
12	R	Anode is at opposite side of feeding holes.		С	G	C/ N	-	U/ C/ D R/ M	

Reel Dimensions

(Unit: mm)



Note: The above shows the dimensions of ϕ 180 reel. In case of ϕ 330 reel, the appearance shape is slightly different.

Reel Diameter				
φ180	ф330			
φ180 ⁺⁰ ₋₃	ф330±2			
	ф180			

Item	Tape width				
iteiii	8	12			
W1	9.0±0.3	13±0.3			
W2	11.4±1.0	15.4±1.0			

Taping

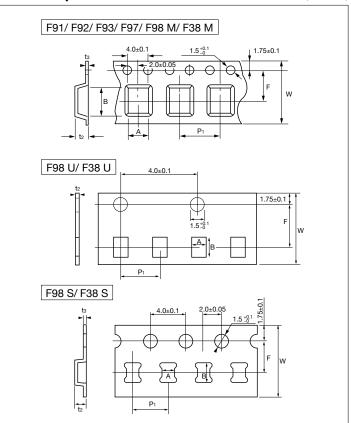
		Q'ty (pc	s / reel)
Series	Case size		Reel Dia.
F00	U	10000	_
F38 F98	М	4000	_
130	S	4000	_
F92	Р	3000	8000
F32	A/B	2500	8000
F91	Α	2000	8000
F93	В	2000	6000
F97	C/ N	500	2500
	R/P	3000	10000
F95	Q/ S/ A/ T	2500	10000
	В	2000	8500
F72	R	1000	_
F/2	М	500	_
F75	U/ C/ D/ R	500	_

Note: Series shall be replaced as necessary.

Note: Series shall be replaced as necessary.								
Series	Replaced	Series	Replaced					
F91	F91 F91-AJ6	F97	F97 F97-HT3					
F93	F93 F93-AJ6	F98	F98 F98-AS1					
F95	F95 F95-AM1							

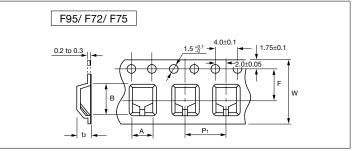
Carrier Tape Dimensions

(Unit: mm)



Case size	W	Α	В	F	P ₁	t ₂	t 3
U		0.73±0.08	1.20±0.05	3.5±0.05	2.0±0.1	0.7 max.	_
M		0.97±0.05	1.85±0.05	3.5±0.05		1.3 max.	0.20±0.05
S	8.0±0.3	1.35±0.1	2.15±0.1	3.5±0.1		1.4 max.	
Р		1.55±0.1	2.3±0.1		4.0±0.1	(1.7 max.)	
Α		1.9±0.1	3.5±0.1	3.5±0.05		2.1 max. (1.7)	0.2 to 0.3
В		3.3±0.1	3.8±0.1			2.4 max. (1.7)	0.2 10 0.3
С	12.0±0.3	3.6±0.1	6.3±0.1	5.5±0.05	8.0±0.1	2.9 max.	
N		4.8±0.1	7.7±0.1	5.5±0.05	o.u±0.1	3.5 max.	

Figures in () at t_2 are applicable to F92 series.



Series	Case size	W	Α	В	F	P ₁	t 2
	R		1.5±0.2	2.6±0.2	3.5±0.05	4.0±0.1	1.05 max.
	Р						1.5 max.
F95	Q/S	0 0+0 0	2.0±0.2	3.6±0.2			1.5 max.
Lao	Α	8.0±0.3	2.1±0.2	3.7±0.2			2.0 max.
	Т		3.0±0.2	3.75±0.2			1.5 max.
	В		3.25±0.2	3.7±0.2			2.4 max.
F72	R	12.0±0.3	6.5±0.2	7.6±0.2	5.5±0.1	8.0±0.1	2.2 max.
F/2	М		6.6±0.2	7.8±0.2			2.5 max.
	U		3.7±0.2	7.6±0.2			2.7 max.
F75	С						3.6 max.
175	D		4.8±0.2	7.9±0.2			3.9 max.
	R		6.7±0.2	7.6±0.2			4.6 max.

Tantalum Capacitors Precautions



The schematics, graphs and numerical values that appear in our catalog are a representative sampling of typical usage. These will differ due to series, ratings and lot variation. Therefore, please contact us to confirm the specific characteristics.

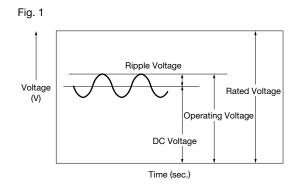
Note: Series shall be replaced as necessary.

Series	Replaced	Series	Replaced
F91	F91 F91-AJ6	F97	F97 F97-HT3
F93	F93 F93-AJ6	F98	F98 F98-AS1
F95	F95 F95-AM1		

1. Circuit Design

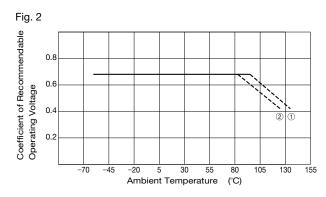
(1) Rated Voltage and Operating Voltage

As shown in Fig.1, rated voltage signifies the maximum peak voltage applied to the capacitor at the maximum rated temperature. The rated voltage consists of the sum of both DC voltage and ripple peak voltage. It is recommended that capacitors are used at a voltage less than the rated voltage. (Reduced rated voltage should be applied at the temperature higher than 85°C)



It is also recommended to properly derate the voltage to improve operating reliability.

Fig.2 is commonly used to consider the derated voltage.



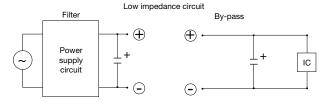
①F97-HT3 series (135°C type)

②Other series (except F38 serie

(2) Low Impedance Circuit

In low impedance circuit applications such as power supply circuits, the failure rate may increase due to inrush current. Additionally, if a short occurs within the capacitor, burning may possibly occur. Therefore, sufficient voltage derating (less than 1/2 of rated voltage) is recommended. If you need assistance, please contact us.





(3) Regarding the applied voltage of conductive polymer tantalum F38 series, we recommend the applied voltage shown in following table. Recommended operating voltage (Rated voltage ratio)

Туре	F	38	F38-LZT/ F38-AXE	
Rated voltage	6.3V	10V	6.3V	
Use in High Impedance circuit	Less than 90%	Less than 80%	Less than 70%	
Use in Low Impedance circuit	Less than 90%	Less than 80%	Less than 70%	

(4) Operating Temperature

All parts must be used within the specified category temperature range, since, the temperature has a great effect on reliability. Therefore, when using capacitors, please try to keep the temperature as low as possible. Please take into consideration that the capacitor itself generates heat which affects the atmospheric temperature.

Tantalum Capacitors Precautions



(5) Ripple Capability

The ripple capability of solid tantalum electrolytic capacitors is defined by both Equivalent Series Resistance (ESR) and power dissipation due to ripple current.

If the capacitor sees a higher ripple current than specified amount, heat generation within the capacitor will increase eventually causing a failure.

The capacitors should be used at a voltage less than the rated voltage that consists of the sum of both DC voltage and ripple peak voltage. Also, reverse voltage due to variation of ripple peak voltage should not be applied to the capacitor.

If you need detailed information about permissible ripple voltage and permissible ripple current, please contact us.

(6) Reverse Voltage

Solid tantalum electrolytic capacitors are polarized, and therefore, no reverse voltage is acceptable. (Electrical characteristics shall be deteriorated when reverse voltage is applied.) When checking a part using a tester, please make sure the polarity of the tester before the probes touch both capacitor terminals.

- (7) Leakage current value differs depending on the voltage applied. Please use higher ratings, especially when it is used in the integration circuit or time-constant circuit.
- (8) Low voltage application or high resistance connected to the capacitor in series,

a problem could possibly result if the following application exists:

Low voltage, high resistance connected to the capacitor in series, and a circuit is sensitive to leakage current, a problem could occur due to the lower recovery of the leakage current characteristic of tantalum capacitor, caused by heat stress during the soldering process.

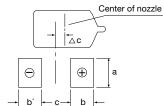
(9) Cautions on designing

When tantalum capacitor is used at high frequency circuit, please note that the electrical characteristics may change drastically.

2. Mounting

(1) Recommended mounting pad dimensions for chip type are as shown in Table -1 and Table -2. Dimensions may vary depending upon reflow conditions, type of solder and/or board size.





[Cautions when mounting F72, F75, and F95 chip]

Adjustment of ΔC toward anode side is required when mounting, as there is a difference between the center of total length of anode tab

Table-3 Conformal - coated chip

F72/ F75 b'

(凸 portion) and the center of board land dimension.

Table-1 Resin - molded chip

iabie i ricelli molaca cinp							
Type	F91/ F92/ F93/ F97/ F98/ F38						
Case	а	b	b'	С			
U	0.35	0.4	0.4	0.4			
М	0.65	0.7	0.7	0.6			
S	0.9	0.7	0.7	0.8			
Р	1.0	1.1	1.1	0.4			
Α	1.3	1.4	1.4	1.0			
В	2.3	1.4	1.4	1.3			
С	2.3	2.0	2.0	2.7			
N	2.5	2.0	2.0	4.0			

Table-2 Conformal - coated chip

Type	F95				
Case	а	b	b'	С	Δc
R/P	1.4	0.6	0.5	0.7	0.2
Q/S	1.7	0.7	0.6	1.1	0.2
Α	1.8	0.7	0.6	1.1	0.2
Т	2.6	0.7	0.6	1.2	0.2
В	2.6	0.8	0.7	1.1	0.2

In the case of F95/ F72/ F75

except anode tab (portion) length.

(2) Soldering temperature and soldering time for chip type should be within limits as shown below when measured at terminal surface. In case you repeat soldering process more than 1 time, please contact us for advice.

Board size, distribution of reflow temperature and capacitor position on the circuit board will influence to reflow conditions.

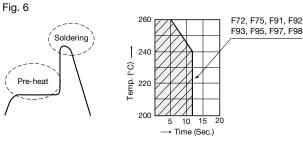
Please check actual reflow condition before applying condition shown in Fig. 5. In case you repeat soldering process more than 1 time, please contact us for advice.

■ F72, F75, F91, F92, F93, F95, F97, F98

• Reflow (Infrared Ray, Hot Plate, Hot Air, etc.)

Fig. 5 F72, F75, F91, F92 F93, F95, F97, F98 ŝ Time (Sec.)

Flow (Dipping, Wave Soldering, etc.)



(Pre-heat is subject to "Reflow.")

Vapor Phase Soldering

30 sec. max. at 215°C (Pre-heat is subject to "Reflow".) Series: F72, F75, F91, F92, F93, F95, F97, F98

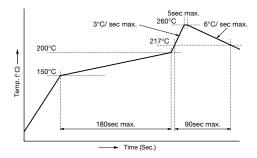
Tantalum Capacitors Precautions



■ F38

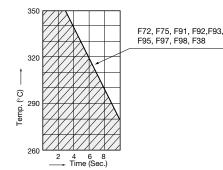
Reflow (Infrared Ray, Hot Plate, Hot Air, etc.)

Fig. 7



All series

Soldering-iron (30 watts or less)



NOTE: Preheat is required to reduce heat shock regardless of the method of soldering. Preheat time for F72, F75, and F95 series should be as long as possible.

(3) Cleaning

Please wash PC board as soon as possible after soldering process to eliminate flux, and acid and alkaline material. In case of ultrasonic cleaning, attention should be paid to the following:

2 Do not allow a circuit board to touch the agitator.

① Cleaning condition: Frequency = 25 to 40kHz,

Power = 10 to 20W/ I, Time = within 3 minutes. ③ Do not stack circuit boards in the cleaning bath.

3. Notes on Storage

- It is desirable to store capacitors at normal temperatures 35°C Max. and normal humidity.
- · Keep out of direct sunlight.
- Don't apply force to capacitor body, especially terminal.
- Don't apply shock and vibration by dropping etc.
- For moisture-proof packed products, keep in sealed storage bag.
- Unseal the storage bag just before mounting and be conscious to use up the capacitors. If some capacitors remained, return the capacitors with desiccant into the storage bag and seal the unsealed part.
- Once the storage bag is opened, store the capacitors in the ambient conditions and time shown in the below table.

		0 0		'
ſ	MSL	Time	Condition	
	3	168 hours	≤30°C/ 60%RH	Compliant to IPC/ JEDEC J-STD-020D

• It is preferable to store for no more than 1 year under the above condition. (when you use part that has been stored more than 1 year, please contact as for assistance)

4. Disposal of capacitors

When disposing, scrap it as industrial wastes.

5. Others

- (1) This product has been designed and manufactured for general electronic equipment. If you use them on extremely high quality or safety electronic equipment such as Medical equipment, Aerospace equipment, etc., please contact us for conformity specifications.
- ② The above mentioned material is according to EIAJ RCR-2368B (revised in March 2002, titled "Guideline of notabilia for fixed tantalum electrolytic capacitors with solid electrolyte for use in electronic equipment"). Please refer to this book for details.
- 3 Please refer to AVX individual technical material for further information of 2 and contents in this catalog.

■ The corelations among rated voltage, surge voltage and derated voltage are as shown.

F72/F75/F91/F92/F93/F95/F97/F98

Rated voltage (V) [≤85°C*] 2.5 4 6.3 10 16 20 25 35 **85°C*** Surge voltage (V) 3.2 5.2 8 13 20 26 32 46

F92-LZT/ F98-LZT/ F98-AXE **Rated voltage (V) [≤60°C]** 6.3 10 **85°C Derated voltage (V)** 4.8 7.2 125°C Derated voltage (V) 2.5 4

Rated voltage (V) [≤85°C] 6.3 10 85°C Surge voltage (V) 8 13 105°C Derated voltage (V) 5 8

Rated voltage (V) [≤60°C]	4	6.3
60°C Surge voltage (V)	_	8
85°C Derated voltage (V)	2.8	4.5
105°C Derated voltage (V)	2	3.3

F38-LZT/F38-AXE

^{125°}C* Derated voltage (V) 1.6 2.5 4 6.3 10 13 16 22 * In case of F97-HT3, 85°C and 125°C shall be 95°C and 135°C respectively